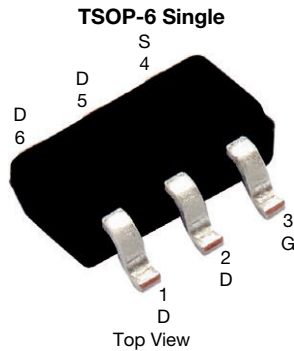


## P-Channel 12 V (D-S) MOSFET



Marking code: AR

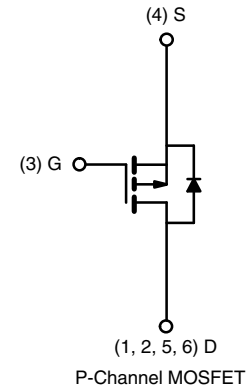
PRODUCT SUMMARY	
$V_{DS}$ (V)	-12
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -4.5$ V	0.022
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -2.5$ V	0.028
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -1.8$ V	0.036
$Q_g$ typ. (nC)	26
$I_D$ (A) <sup>a</sup>	-8
Configuration	Single

### FEATURES

- TrenchFET® power MOSFET
- PWM optimized
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)

### APPLICATIONS

- Load switch
- PA switch


**RoHS**  
 COMPLIANT  
 HALOGEN  
**FREE**  
 Available


ORDERING INFORMATION	
Package	TSOP-6
Lead (Pb)-free	Si3473CDV-T1-E3
Lead (Pb)-free and halogen-free	Si3473CDV-T1-GE3

ABSOLUTE MAXIMUM RATINGS ( $T_A = 25$ °C, unless otherwise noted)				
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		$V_{DS}$	-12	V
Gate-source voltage		$V_{GS}$	$\pm 8$	
Continuous drain current ( $T_J = 150$ °C)	$T_C = 25$ °C	$I_D$	-8 <sup>a</sup>	A
	$T_C = 70$ °C		-8 <sup>a</sup>	
	$T_A = 25$ °C		-8 <sup>a, b, c</sup>	
	$T_A = 70$ °C		-6.5 <sup>b, c</sup>	
Pulsed drain current		$I_{DM}$	-20	
Continuous source-drain diode current	$T_C = 25$ °C	$I_S$	-3.5	
	$T_A = 25$ °C		-1.67 <sup>b, c</sup>	
Maximum power dissipation	$T_C = 25$ °C	$P_D$	4.2	W
	$T_C = 70$ °C		2.7	
	$T_A = 25$ °C		2 <sup>b, c</sup>	
	$T_A = 70$ °C		1.3 <sup>b, c</sup>	
Operating junction and storage temperature range		$T_J, T_{stg}$	-55 to +150	°C

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient <sup>b, d</sup>	$t \leq 5$ s	$R_{thJA}$	55	62.5	°C/W
Maximum junction-to-foot (drain)	Steady state	$R_{thJF}$	25	30	

### Notes

- Package limited
- Surface mounted on 1" x 1" FR4 board
- $t = 5$  s
- Maximum under steady state conditions is 110 °C/W



SPECIFICATIONS ( $T_J = 25\text{ }^\circ\text{C}$ , unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
<b>Static</b>						
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0\text{ V}$ , $I_D = -250\text{ }\mu\text{A}$	-12	-	-	V
$V_{DS}$ temperature coefficient	$\Delta V_{DS}/T_J$	$I_D = -250\text{ }\mu\text{A}$	-	-13	-	mV/ $^\circ\text{C}$
$V_{GS(th)}$ temperature coefficient	$\Delta V_{GS(th)}/T_J$		-	3	-	
Gate-source threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = -250\text{ }\mu\text{A}$	-0.4	-	-1	V
Gate-source leakage	$I_{GSS}$	$V_{DS} = 0\text{ V}$ , $V_{GS} = \pm 8\text{ V}$	-	-	$\pm 100$	nA
Zero gate voltage drain current	$I_{DSS}$	$V_{DS} = -12\text{ V}$ , $V_{GS} = 0\text{ V}$	-	-	-1	$\mu\text{A}$
		$V_{DS} = -12\text{ V}$ , $V_{GS} = 0\text{ V}$ , $T_J = 85\text{ }^\circ\text{C}$	-	-	-10	
On-state drain current <sup>a</sup>	$I_{D(on)}$	$V_{DS} \leq -5\text{ V}$ , $V_{GS} = -4.5\text{ V}$	-20	-	-	A
Drain-source on-state resistance <sup>a</sup>	$R_{DS(on)}$	$V_{GS} = -4.5\text{ V}$ , $I_D = -8.1\text{ A}$	-	0.016	0.022	$\Omega$
		$V_{GS} = -2.5\text{ V}$ , $I_D = -7.1\text{ A}$	-	0.021	0.028	
		$V_{GS} = -1.8\text{ V}$ , $I_D = -2.8\text{ A}$	-	0.026	0.036	
Forward transconductance <sup>a</sup>	$g_{fs}$	$V_{DS} = -6\text{ V}$ , $I_D = -8.1\text{ A}$	-	30	-	S
<b>Dynamic <sup>b</sup></b>						
Input capacitance	$C_{iss}$	$V_{DS} = -6\text{ V}$ , $V_{GS} = 0\text{ V}$ , $f = 1\text{ MHz}$	-	2010	-	pF
Output capacitance	$C_{oss}$		-	580	-	
Reverse transfer capacitance	$C_{rss}$		-	520	-	
Total gate charge	$Q_g$	$V_{DS} = -6\text{ V}$ , $V_{GS} = -8\text{ V}$ , $I_D = -8.1\text{ A}$	-	43	65	nC
Gate-source charge		$Q_{gs}$	$V_{DS} = -6\text{ V}$ , $V_{GS} = -4.5\text{ V}$ , $I_D = -8.1\text{ A}$	-	26	
Gate-drain charge	$Q_{gd}$			-	3.3	
Gate resistance	$R_g$	$f = 1\text{ MHz}$	-	7.5	-	
Turn-on delay time	$t_{d(on)}$	$V_{DD} = -6\text{ V}$ , $R_L = 0.92\text{ }\Omega$ $I_D \cong -6.5\text{ A}$ , $V_{GEN} = -4.5\text{ V}$ , $R_g = 1\text{ }\Omega$	-	4.8	-	ns
Rise time	$t_r$		-	20	30	
Turn-off delay time	$t_{d(off)}$		-	55	85	
Fall time	$t_f$		-	60	90	
Turn-on delay time	$t_{d(on)}$	$V_{DD} = -6\text{ V}$ , $R_L = 0.92\text{ }\Omega$ $I_D \cong -6.5\text{ A}$ , $V_{GEN} = -8\text{ V}$ , $R_g = 1\text{ }\Omega$	-	40	60	
Rise time	$t_r$		-	10	15	
Turn-off delay time	$t_{d(off)}$		-	15	25	
Fall time	$t_f$		-	62	95	
			-	35	55	
<b>Drain-Source Body Diode Characteristics</b>						
Continuous source-drain diode current	$I_S$	$T_C = 25\text{ }^\circ\text{C}$	-	-	-3.5	A
Pulse diode forward current <sup>a</sup>	$I_{SM}$		-	-	-20	
Body diode voltage	$V_{SD}$	$I_S = -5.9\text{ A}$	-	-0.8	-1.2	V
Body diode reverse recovery time	$t_{rr}$	$I_F = -6.5\text{ A}$ , $di/dt = 100\text{ A}/\mu\text{s}$ , $T_J = 25\text{ }^\circ\text{C}$	-	50	75	ns
Body diode reverse recovery charge	$Q_{rr}$		-	30	45	nC
Reverse recovery fall time	$t_a$		-	18	-	ns
Reverse recovery rise time	$t_b$		-	32	-	

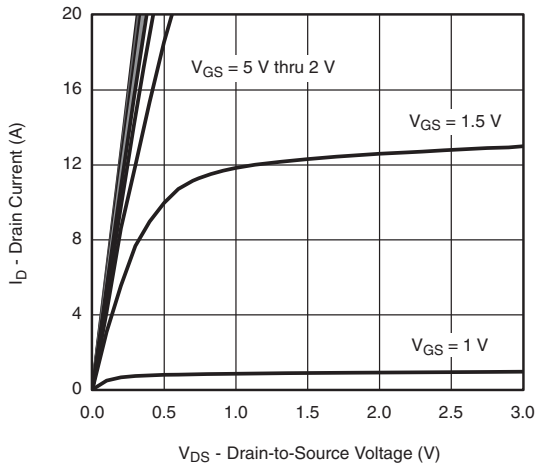
**Notes**

- a. Pulse test; pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$   
b. Guaranteed by design, not subject to production testing

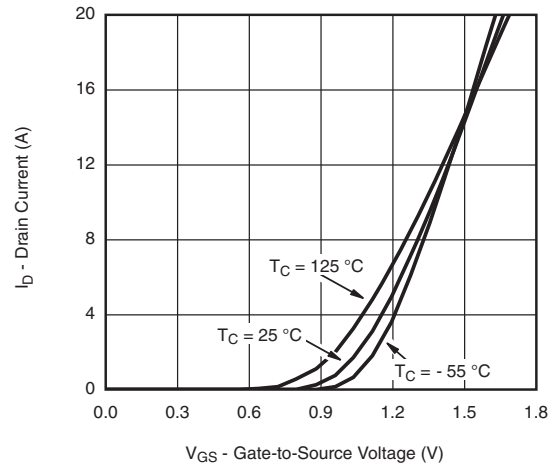
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



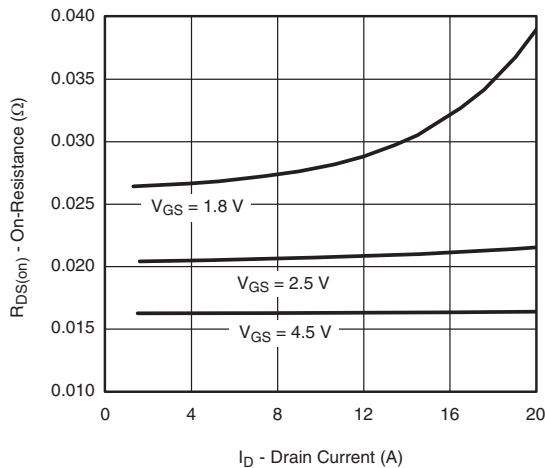
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



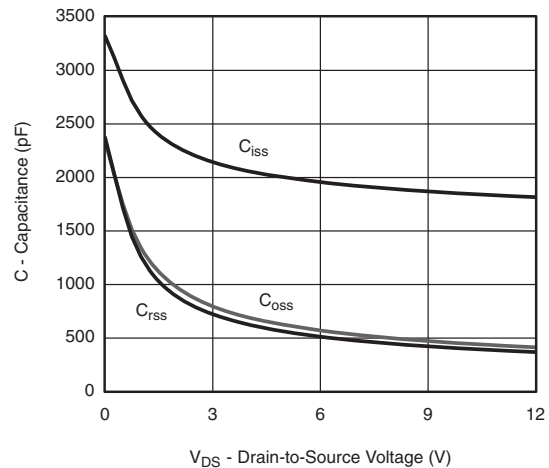
Output Characteristics



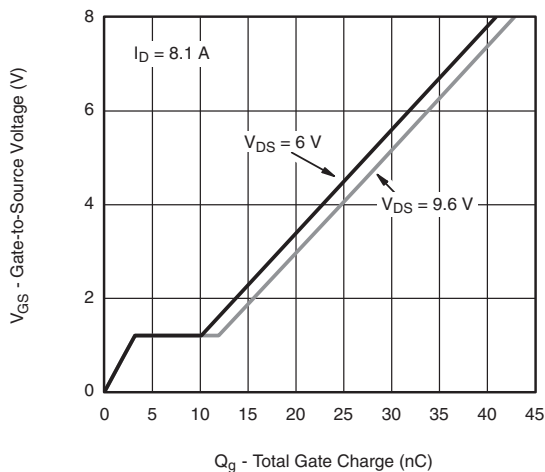
Transfer Characteristics



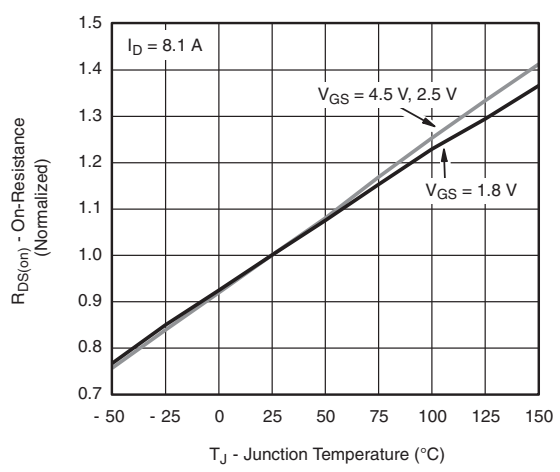
On-Resistance vs. Drain Current and Gate Voltage



Capacitance



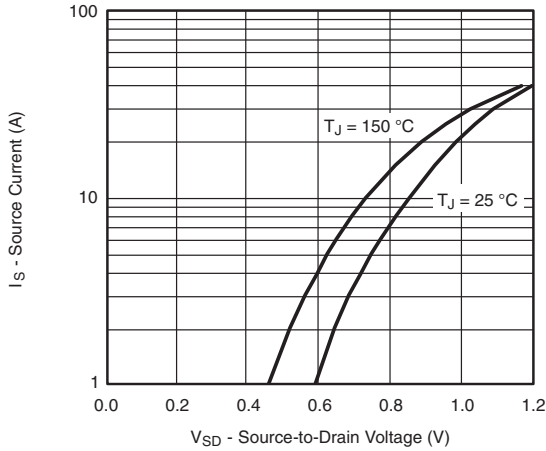
Gate Charge



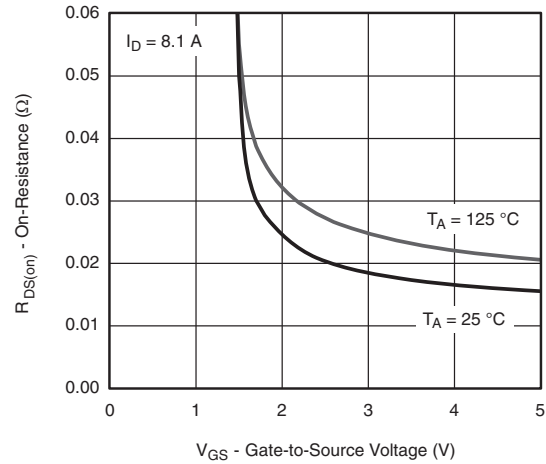
On-Resistance vs. Junction Temperature



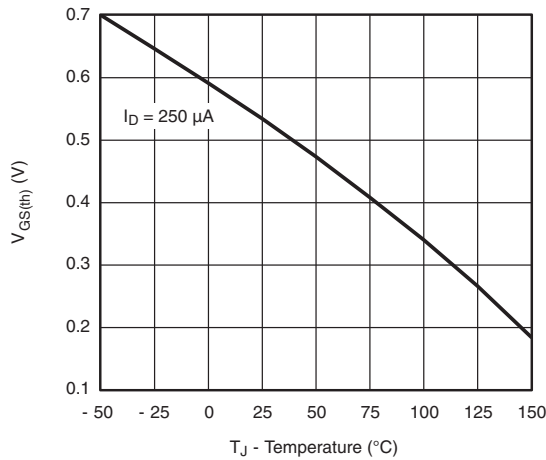
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



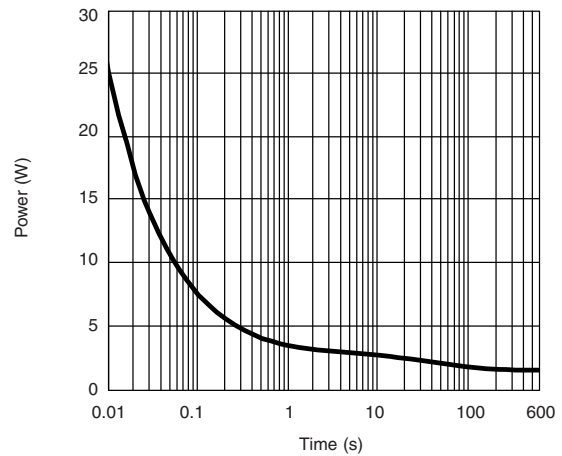
Source-Drain Diode Forward Voltage



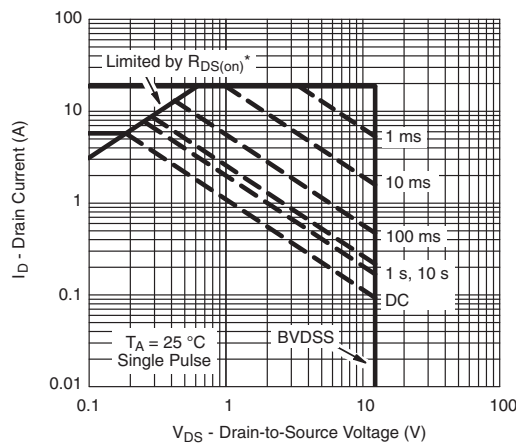
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



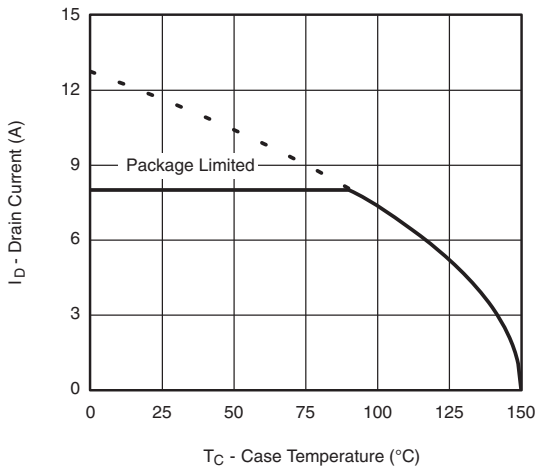
Single Pulse Power



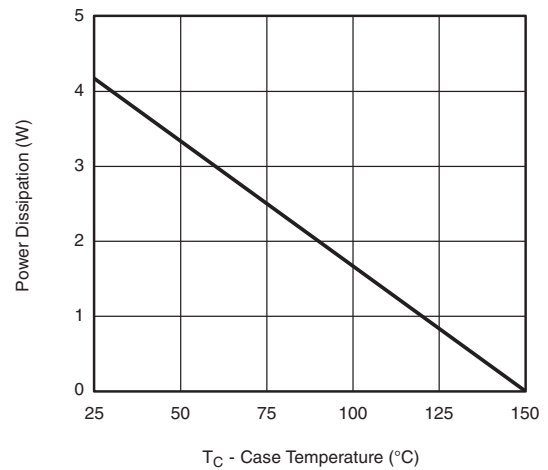
Safe Operating Area



**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)



**Current Derating <sup>a</sup>**



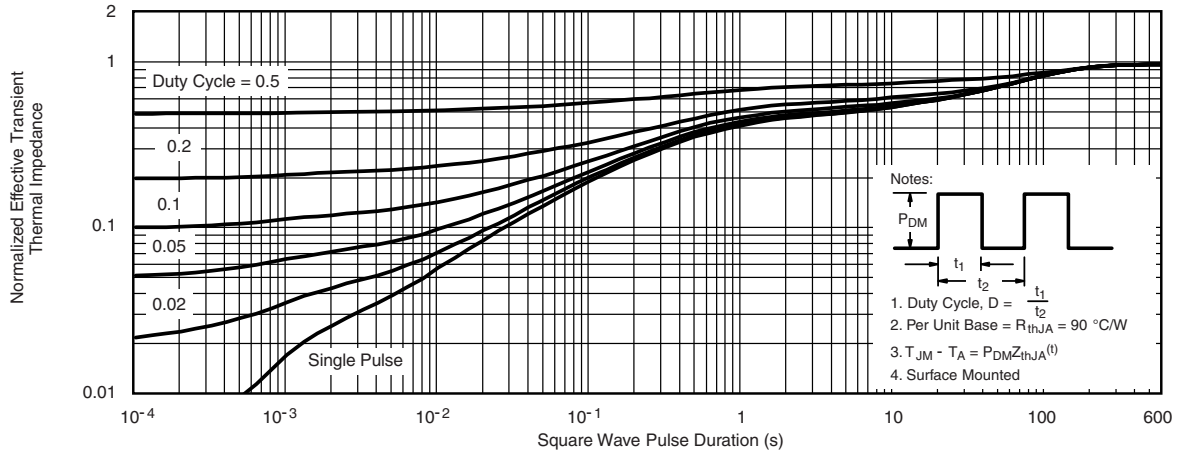
**Power, Junction-to-Foot**

**Note**

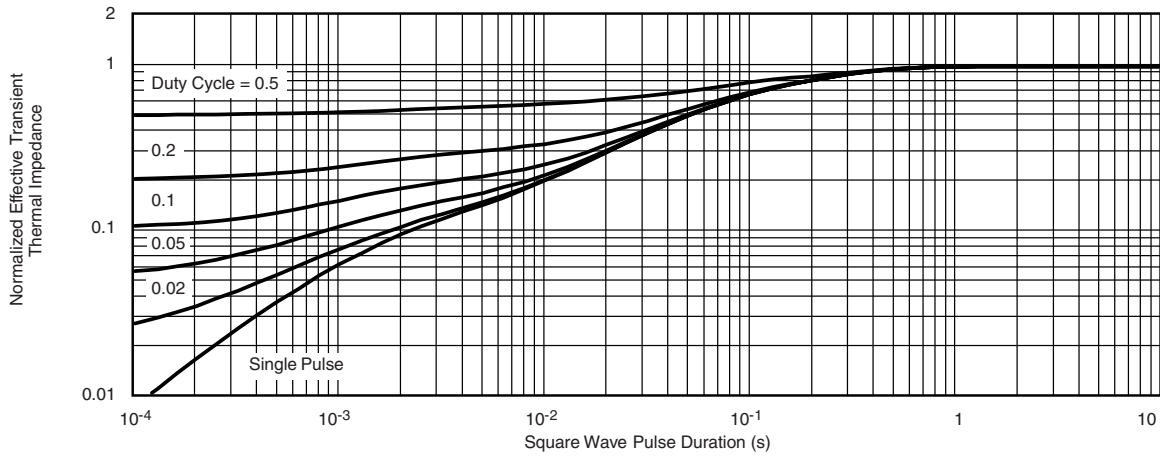
- a. The power dissipation  $P_D$  is based on  $T_J$  max = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)



**Normalized Thermal Transient Impedance, Junction-to-Ambient**



**Normalized Thermal Transient Impedance, Junction-to-Foot**

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## TSOP: 5/6-LEAD

JEDEC Part Number: MO-193C



**5-LEAD TSOP**



**6-LEAD TSOP**



Dim	MILLIMETERS			INCHES		
	Min	Nom	Max	Min	Nom	Max
<b>A</b>	0.91	-	1.10	0.036	-	0.043
<b>A<sub>1</sub></b>	0.01	-	0.10	0.0004	-	0.004
<b>A<sub>2</sub></b>	0.90	-	1.00	0.035	0.038	0.039
<b>b</b>	0.30	0.32	0.45	0.012	0.013	0.018
<b>c</b>	0.10	0.15	0.20	0.004	0.006	0.008
<b>D</b>	2.95	3.05	3.10	0.116	0.120	0.122
<b>E</b>	2.70	2.85	2.98	0.106	0.112	0.117
<b>E<sub>1</sub></b>	1.55	1.65	1.70	0.061	0.065	0.067
<b>e</b>	0.95 BSC			0.0374 BSC		
<b>e<sub>1</sub></b>	1.80	1.90	2.00	0.071	0.075	0.079
<b>L</b>	0.32	-	0.50	0.012	-	0.020
<b>L<sub>1</sub></b>	0.60 Ref			0.024 Ref		
<b>L<sub>2</sub></b>	0.25 BSC			0.010 BSC		
<b>R</b>	0.10	-	-	0.004	-	-
<b>θ</b>	0°	4°	8°	0°	4°	8°
<b>θ<sub>1</sub></b>	7° Nom			7° Nom		
ECN: C-06593-Rev. I, 18-Dec-06						
DWG: 5540						



## Recommended Land Pattern For TSOP-5L / TSOP-6L



**Note**

- All dimensions are in inches (millimeter)

ECN: C22-0860-Rev. B, 24-Oct-2022  
DWG: 3010





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